P16B6SB

Power MOSFETs 60V, 16A, N-channel

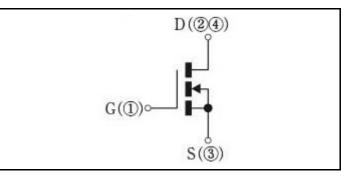
Feature

- N-channel
- SMD
- Low Ron
- 4.5V Gate Drive
- Low Capacitance
- Pb free terminal
- RoHS:Yes

OUTLINE



Equivalent circuit



Absolute Maximum Ratings (unless otherwise specified : Tc=25°C)

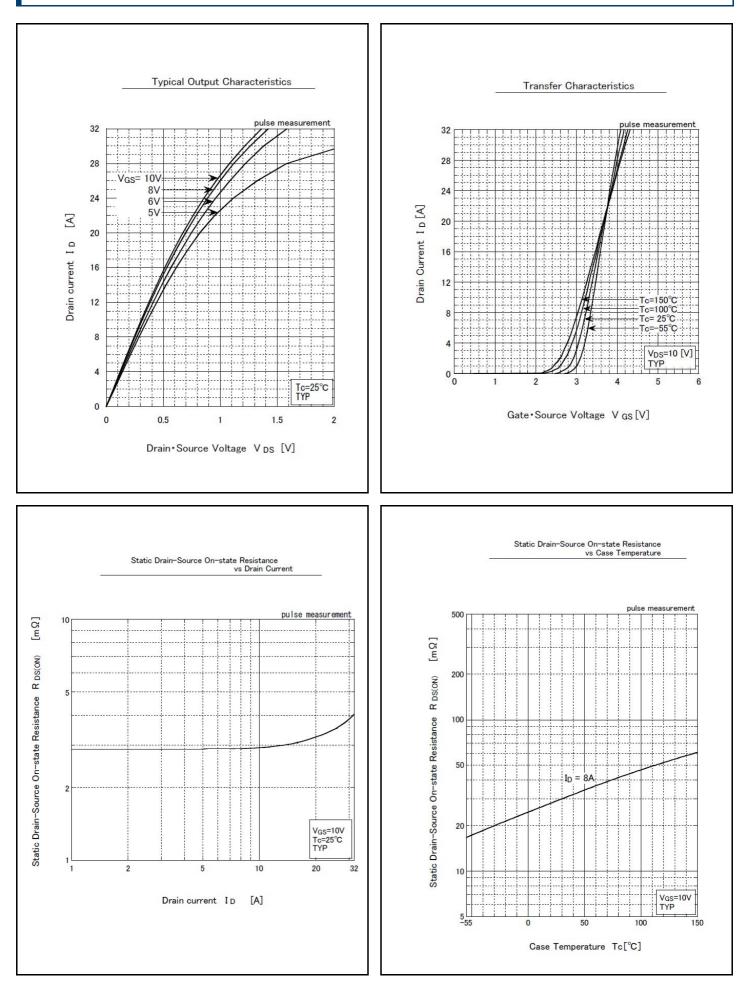
Item	Symbol	Conditions	Ratings	Unit
Storage temperature	Tstg		-55 to 150	°C
Channel tempertature	Tch		150	°C
Drain-source voltage	V _{DSS}		60	V
Gate-source voltage	V _{GSS}		±20	V
Continuous drain current(DC)	I _D		16	A
Continuous drain current(Peak)	I _{DP}	Pulse width 10µs, duty=1/100	48	A
Total power dissipation	P _T		20	W
Single avalanche current	I _{AS}	Starting Tch=25°C Tch≦150°C	12	A
Single avalanche energy	E _{AS}	Starting Tch=25°C Tch≦150°C	14.8	mJ

* : See the original Specifications

Item	Symbol		Ratings			11
		Conditions		ТҮР	MAX	Unit
Drain-Source breakdown voltage	V _{(BR)DSS}	ID=1mA, VGS=0V	60			V
Zero gate voltage drain current	I _{DSS}	VDS=60V, VGS=0V			1	μA
Gate-source leakage current	I _{GSS}	VGS=±20V, VDS=0V			±10	μA
Forward transconductance	g _{fs}	ID=8A, VDS=10V	4			S
Static drain-source on-state resistance	R _{DS(ON)}	ID=8A, VGS=10V		0.029	0.037	Ω
Static drain-source on-state resistance	R _{DS(ON)}	ID=8A, VGS=4.5V		0.036	0.048	Ω
Gate threshold voltage	Vth	ID=1mA, VDS=10V	1.5	2	2.5	V
Source-drain diode forward voltage	V _{SD}	IS=16A, VGS=0V			1.5	V
Thermal resistance	Rth(j-c)	Junction to case			6.28	°C/W
Total gate charge	Qg	VDD=48V, VGS=10V, ID=16A		17		nC
Gate to source charge	Qgs	VDD=48V, VGS=10V, ID=16A		4.1		nC
Gate to drain charge	Qgd	VDD=48V, VGS=10V, ID=16A		4		nC
Input capacitance	Ciss	VDS=25V, VGS=0V, f=1MHz		655		pF
Reverce transfer capacitnce	Crss	VDS=25V, VGS=0V, f=1MHz		36		pF
Output capacitance	Coss	VDS=25V, VGS=0V, f=1MHz		85		pF
Turn-on delay time	td(on)	ID=8A, RL=3.75Ω, VDD=30V, Rg=0Ω, VGS(+)=10V, VGS(-)=0V		4		ns
Rise time	tr	ID=8A, RL=3.75Ω, VDD=30V, Rg=0Ω, VGS(+)=10V, VGS(-)=0V		8.5		ns
Turn-off delay time	td(off)	ID=8A, RL=3.75Ω, VDD=30V, Rg=0Ω, VGS(+)=10V, VGS(-)=0V		13.5		ns
Fall time	tf	ID=8A, RL=3.75Ω, VDD=30V, Rg=0Ω, VGS(+)=10V, VGS(-)=0V		4		ns
Diode reverse recovery time	trr	IF=16A, VGS=0V, di/dt=100A/µs		40		ns
Diode reverse recovery charge	Qrr	IF=16A, VGS=0V, di/dt=100A/µs		46		nC

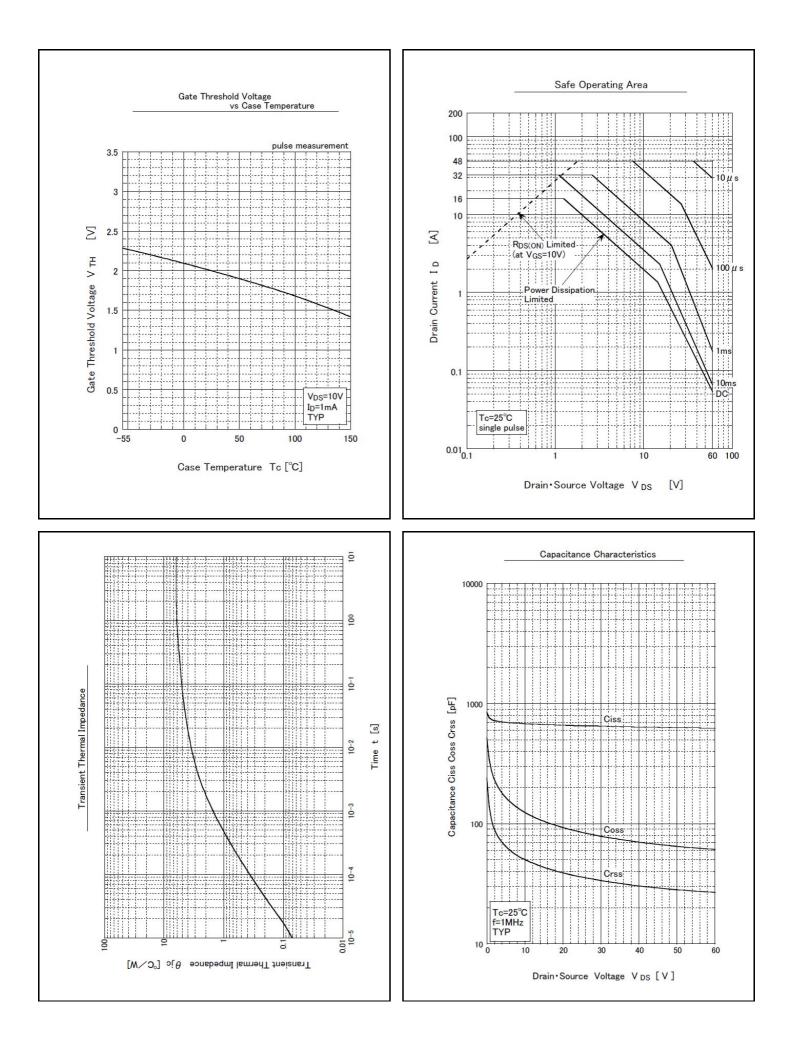
* : See the original Specifications

CHARACTERISTIC DIAGRAMS



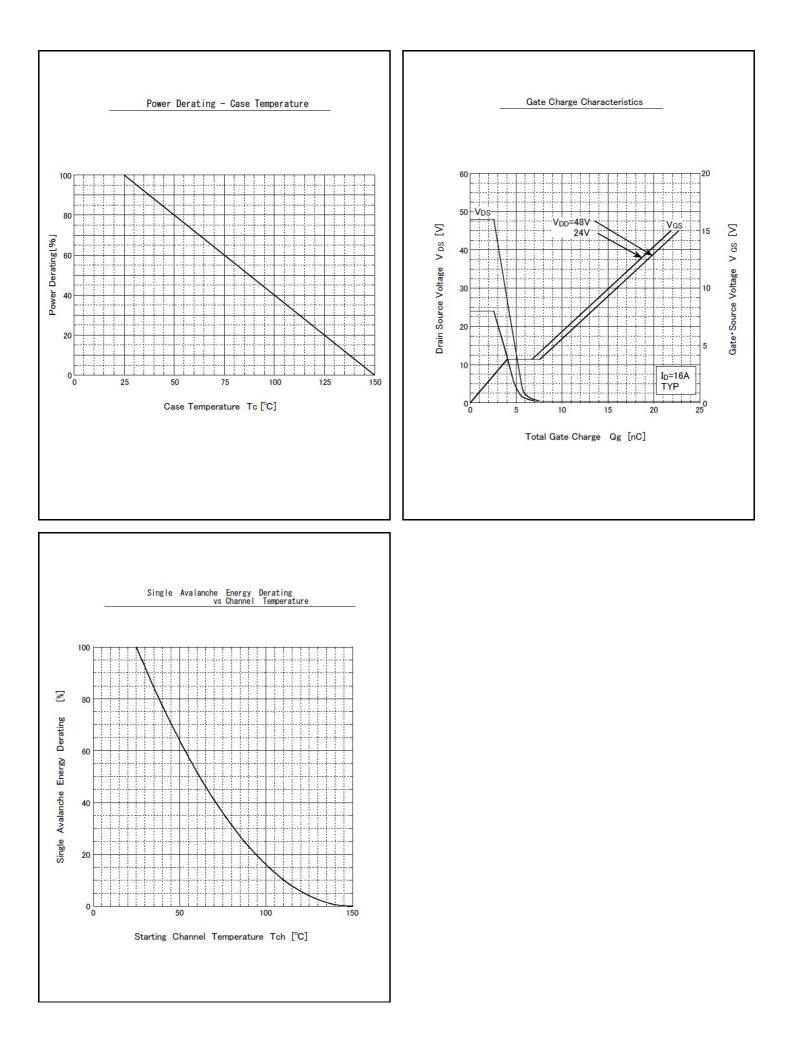
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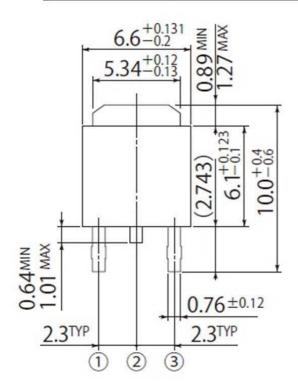
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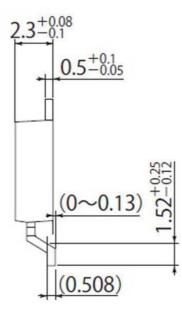


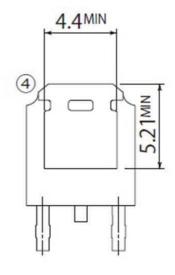
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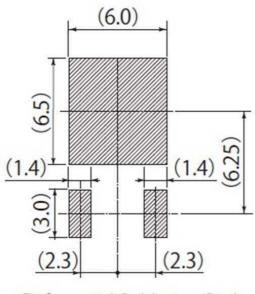
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JEDEC Code	TO-252AA		
JEITA Code	—		
House Name	FB		









Referential Soldering Pad

Optimize soldering pad to the board design and soldering condition.

Notes

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